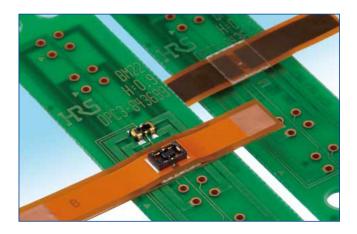


# 4 Amp Micro Hybrid Board to FPC Connectors

BM22 Series



#### ■Features

#### 1. 4 Amp current rating

The space-saving design utilizes two power contacts that can carry up to 4 Amps of current, and two signal contacts that can also carry 0.3 Amps of current. This is all delivered in a small connector that features a small mounting depth of 2.64 mm.

#### 2. Two point contact structure

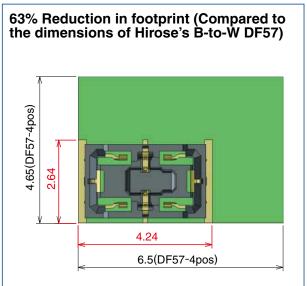
The structure utilizes two points on each contact to ensure a secure connection for both types of contacts (power and signal).

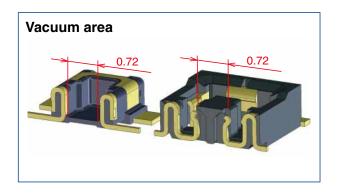
#### 3. Good Mating Operability

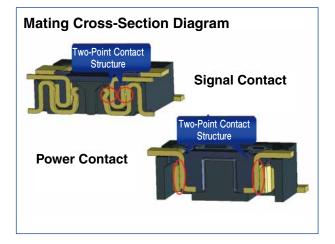
The connector contributes to the enhanced mating operability by giving a clicking feeling which is effective in preventing incomplete mating, and mating self-alignment of 0.3 mm which is secured by the guide ribs.

### **■**Application

Devices that need to be slim and compact such as cell phones and tablet PCs.







### **■**Specifications

_							
		Current	Power contact: 4 Amps/pin	Operating	-35 to 85°C (Note 1)	Storage	-10 to 60°C (Note 2)
	Dotingo	rating	Signal contact: 0.3 Amps/pin	temperature range		temperature range	
	Ratings	Voltage	30 V AC/DC	Operating	20 to 80%	Storage	40 to 70% (Note 2)
		rating		humidity range		humidity range	

Item	Specification	Conditions	
1. Insulation resistance	Minimum of 50 M $\Omega$	Measured at 100 V DC	
2. Withstanding voltage	No flashover or insulation breakdown	Conduct 100 V AC for 1 minute	
3. Contact resistance	Signal contact: Maximum of 50 m $\Omega$ Power contact: Maximum of 30 m $\Omega$	Measured at 20 mV AC, 1 kHz, 1 mA	
4. Vibration	No electrical discontinuity of 1 $\mu$ s or longer	Frequency: 10 to 55 Hz, single amplitude of 0.75 mm, 3 directions, 2 hours	
5. Humidity	Contact resistance: Maximum of 100 m $\Omega$ Insulation resistance: Minimum of 25 M $\Omega$	96 hours at a temperature of 40 ±2°C and a humidity range from 90 to 95%	
6. Temperature cycle	Contact resistance: Maximum of 100 m $\Omega$ Insulation resistance: Minimum of 50 M $\Omega$	(-55°C: 30 minutes $\rightarrow$ 5 to 35°C: 10 minutes $\rightarrow$ 85°C: 30 minutes $\rightarrow$ 5 to 35°C: 10 minutes), 5 cycles	
7. Durability	Contact resistance: Maximum of 100 mΩ	10 mating cycles	
8. Solder Heat Resistance	No signs of melting or deformity on the molded resin parts and no negative effects on performance.	Reflow: according to the Recommended Solder Profile Hand soldering: Soldering iron temperature 350°C, no more than 3 seconds of contact	

Note 1: Includes temperature rise caused by current flow.

Note 2: The term "storage" here refers to products stored for a long period prior to board mounting and use. The operating temperature and humidity range covers the non-energized condition of connectors after board mounting and the temporary storage conditions during transportation, etc.

Note 3: The specifications shown above represent general requirements for this series. Contact us for the drawings and specifications for a specific part number shown

#### ■Material

Product	Part	Material	Finish	UL standard
Receptacle / Header	Insulator	LCP	Black	UL94V-0
neceptacle / neader	Contacts	Copper alloy	Gold plated	

### ■Composition of Product Number

Refer to this page when determining product specifications by model types. Please place orders with part numbers listed in this catalog. The characteristics and specifications of the product described in this catalog are reference values. Please make sure to check the latest delivery specifications at the time of product use.

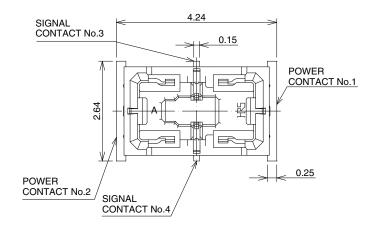
#### Receptacles / Headers

$$\frac{BM}{0} \frac{22}{2} - \frac{*}{8} \frac{S}{4} - \frac{V}{6} \frac{(51)}{6}$$

1 Series name: BM	5 Termination type V: Straight SMT
<ul> <li>2 Series No.: 22</li> <li>3 Number of contacts: <ul> <li>4 (2 for signal and 2 for power)</li> <li>6 (4 for signal and 2 for power)</li> </ul> </li> <li>4 Connector type: <ul> <li>S: Receptacle</li> <li>P: Header</li> </ul> </li> </ul>	6 Gold plated specification and packaging status (51): Gold plate thickness 0.05 μm Embossed tape packaging (10,000 pieces per reel) (78): Gold plate thickness 0.30 μm Embossed tape packaging (10,000 pieces per reel)

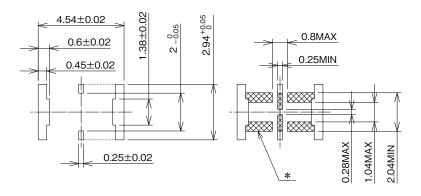
### **■**Receptacles







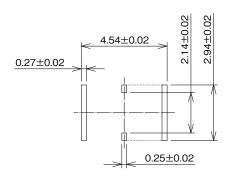
## ■Recommended PCB layout (4 contacts)



#### \*: PCB layout prohibited area

(Do not use different circuit patterns; however the same circuit that is connected to the footprint can be routed over the prohibited area, but soldering resist must be applied over the trace.)

## ■Recommended metal mask dimensions (mask thickness: 100 µm) (4 contacts)

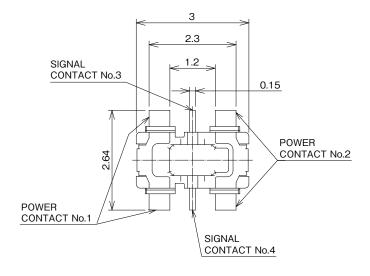


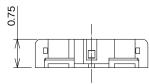
Part No.	HRS No.	Number of Contacts	
BM22-4S-V (51)	CL0677-1002-6-51	4	
BM22-6S-V (51)	CL0677-1004-1-51	6	

(Note) This product is packaged on reels; please place your orders for full reel quantities.

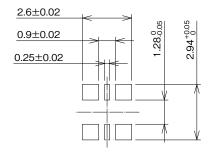
### ■Headers



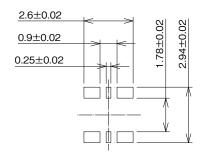




## ■Recommended PCB layout (4 contacts)



## ■Recommended metal mask dimensions (mask thickness: 100 µm) (4 contacts)

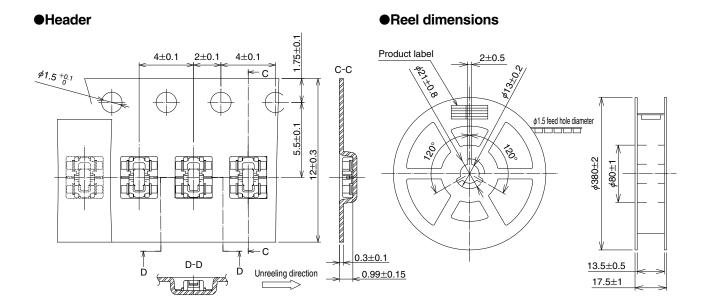


Product Number	HRS No.	Number of Contacts	
BM22-4P-V (51)	CL0677-1001-3-51	4	
BM22-6P-V (51)	CL0677-1003-9-51	6	

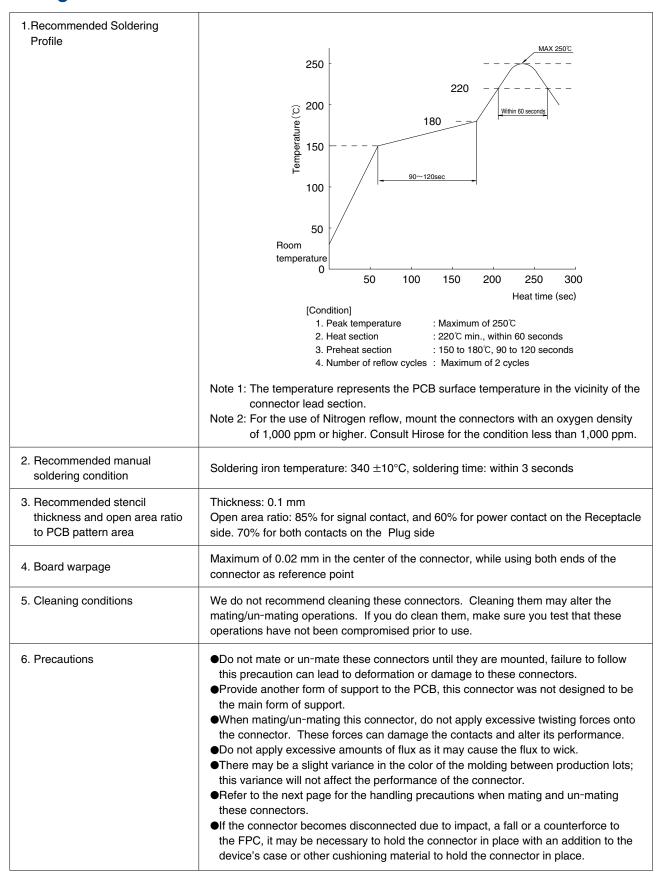
(Note) This product is packaged on reels; please place your orders for full reel quantities.

## **■**Embossed Tape Dimensions (complies with JIS C 0806)

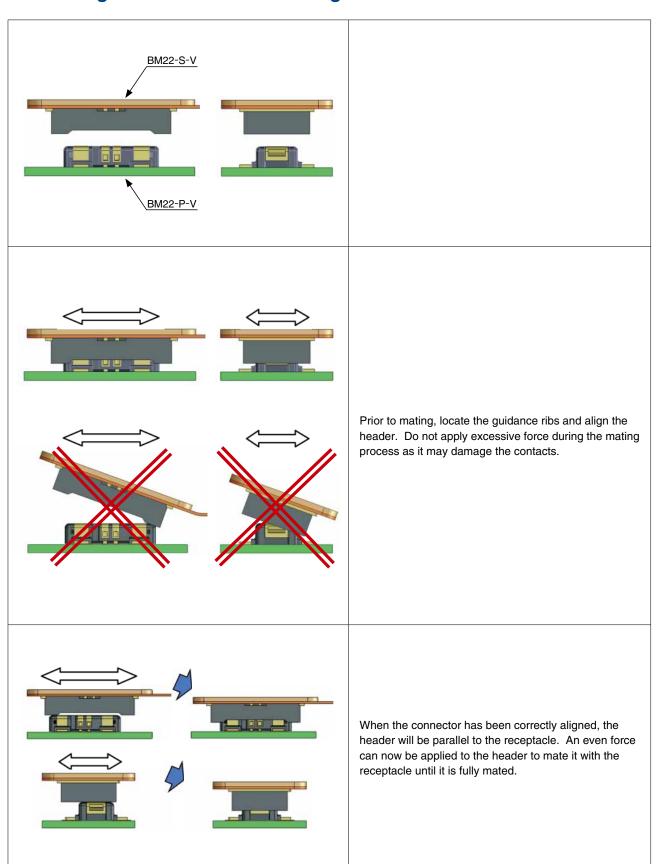
#### Reel dimensions ● Receptacle 1.75±0.1 4±0.1 2±0.1 4±0.1 Product label 2±0.5 Ø1340.2 A-A \$1.5 +0.1 7.5±0.1 ô 6±0.3 *∲*380±2 $\phi 80\pm 1$ 17.5±0.5 В-В 0.3±0.1 B Unreeling direction 21.5±1 1.12±0.15



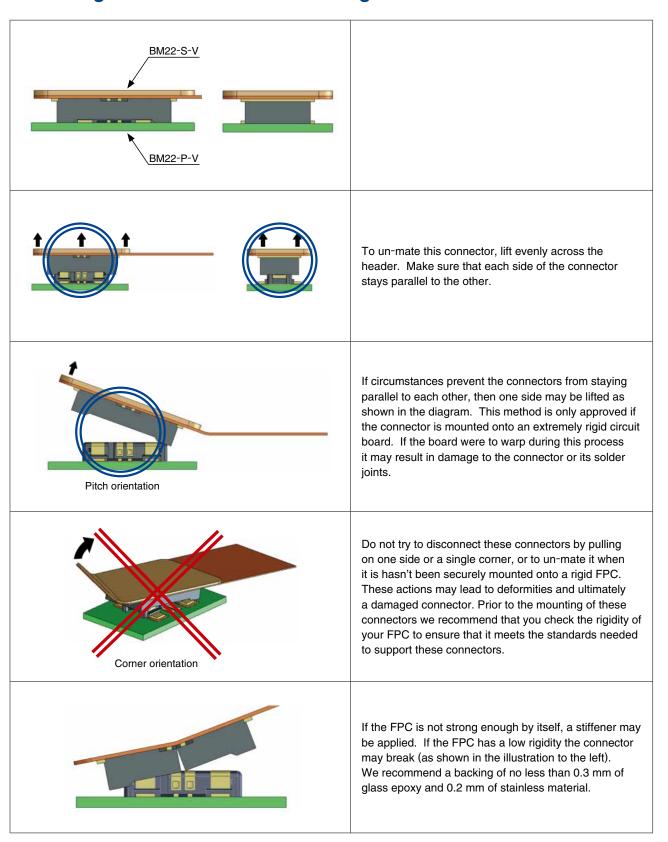
### **■**Usage Recommendations



## **■** Handling Precautions when Mating Connectors



### ■Handling Precautions when Un-mating Connectors





**HS** 

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